

Features

- Split Gate Trench MOSFET Technology
- Excellent package for heat dissipation
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

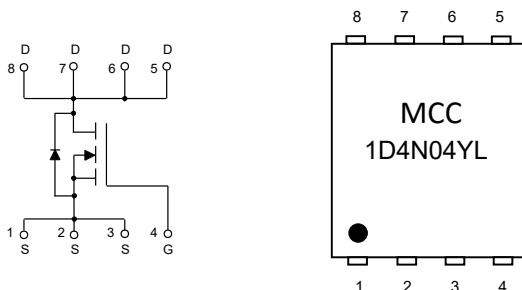
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance:55°C/W Junction to Ambient^(Note2)
- Thermal Resistance:1.5°C/W Junction to Case

Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V_{DS}	40	V
Gate-Source Voltage		V_{GS}	±20	V
Continuous Drain Current	$T_C=25^\circ C$	I_D	185	A
	$T_C=100^\circ C$		117	
Pulsed Drain Current ^(Note3)		I_{DM}	740	A
Total Power Dissipation ^(Note4)		P_D	83	W
Single Pulse Avalanche Energy ^(Note 5)		E_{AS}	900	mJ

Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ C$.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-case thermal resistance.
5. $T_J=25^\circ C$, $V_{DD}=10V$, $V_{GS}=10V$, $R_G=25\Omega$, $L=2mH$.

ꞤhŷfbU`Gfŷi Wŷ fY`UbX`A Uŷ]b[`7 cXY



DFN5060

DIM	DIMENSIONS				NOTE
	INCHES		MM		
	MIN	MAX	MIN	MAX	
A	0.031	0.047	0.80	1.20	
B	0.010		0.254		TYP.
C	0.193	0.222	4.90	5.64	
D	0.232	0.250	5.90	6.35	
E	0.148	0.167	3.75	4.25	
F	0.126	0.154	3.20	3.92	
G	0.189	0.213	4.80	5.40	
H	0.222	0.239	5.65	6.06	
K	0.045	0.059	1.15	1.50	
J	0.012	0.020	0.30	0.50	
L	0.046	0.054	1.17	1.37	
M	0.012	0.028	0.30	0.71	
N	0.016	0.028	0.40	0.71	

Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	40			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=40V, V_{GS}=0V$			1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.3	1.8	2.3	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=50A$		1.1	1.4	m Ω
		$V_{GS}=4.5V, I_D=25A$		1.6	2.2	m Ω
Gate Resistance	R_G	f=1MHz, Open drain		3.5		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				185	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=50A$			1.2	V
Reverse Recovery Time	t_{rr}	$I_F=50A, di/dt=100A/\mu s$		53		ns
Reverse Recovery Charge	Q_{rr}			55		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=20V, V_{GS}=0V, f=1MHz$		6330		pF
Output Capacitance	C_{oss}			1850		
Reverse Transfer Capacitance	C_{rss}			65		
Total Gate Charge	Q_g	$V_{DS}=20V, V_{GS}=10V, I_D=50A$		89		nC
Gate-Source Charge	Q_{gs}			18		
Gate-Drain Charge	Q_{gd}			15		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=20V, V_{GS}=10V, R_G=3\Omega, I_D=50A$		14		ns
Turn-On Rise Time	t_r			15		
Turn-Off Delay Time	$t_{d(off)}$			84		
Turn-Off Fall Time	t_f			44		

Curve Characteristics

Fig.1 - Typical Output Characteristics

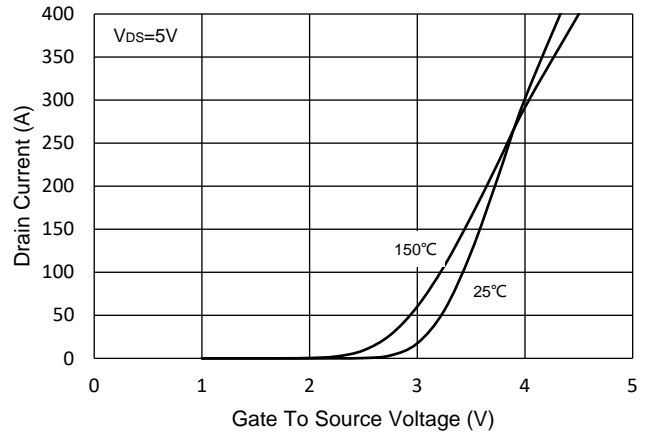
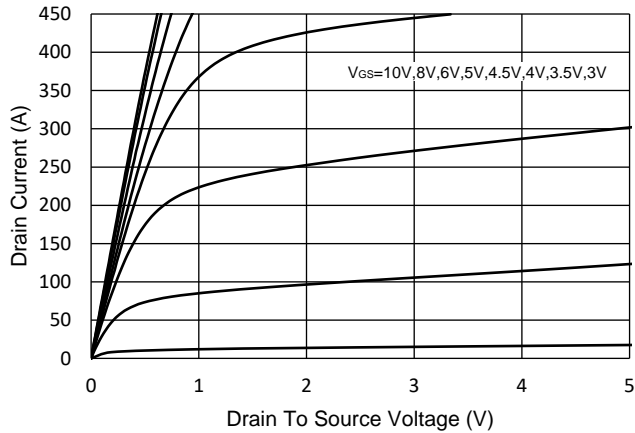


Fig.3 - $R_{DS(ON)}$ - V_{GS}

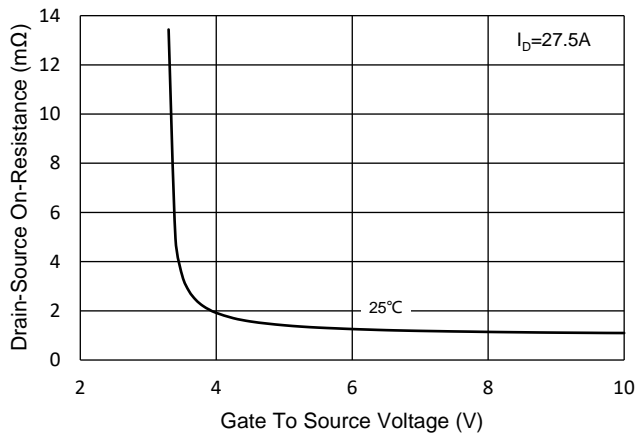


Fig.4 - $R_{DS(ON)}$ - I_D

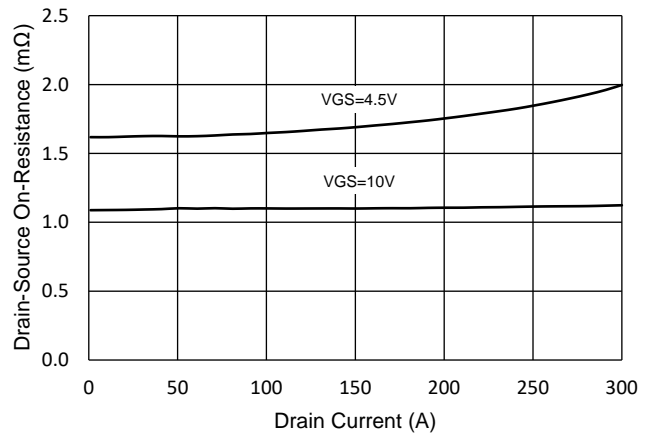


Fig.5 - Capacitance Characteristics

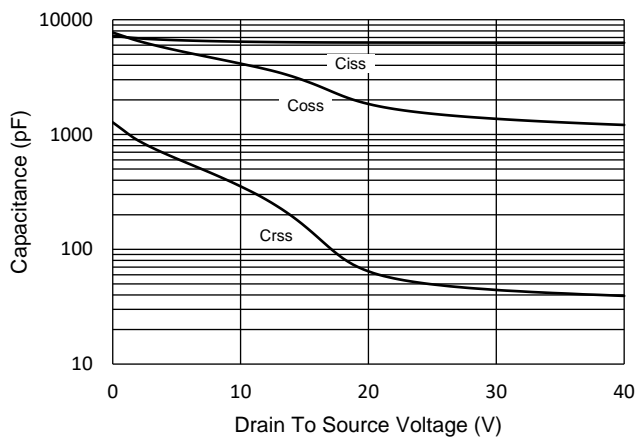
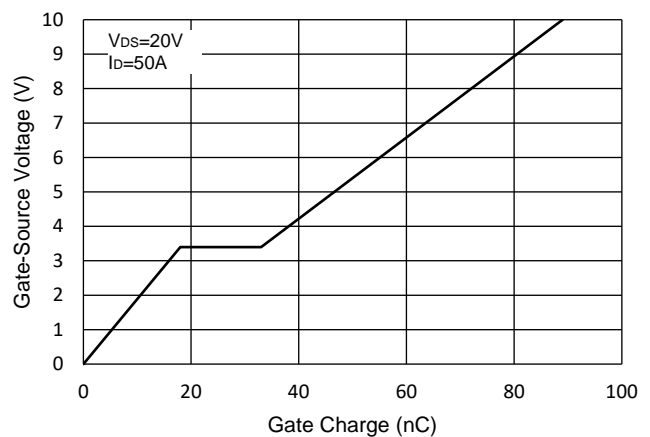


Fig.6 - Gate Charge



Curve Characteristics

Fig.7 - Normalized Threshold Voltage

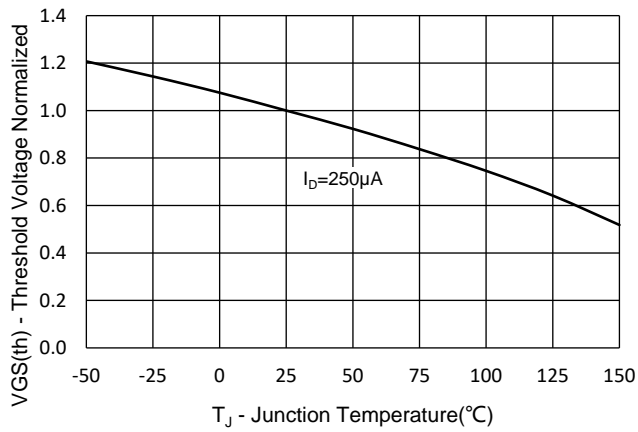


Fig.8 - Normalized On Resistance Characteristics

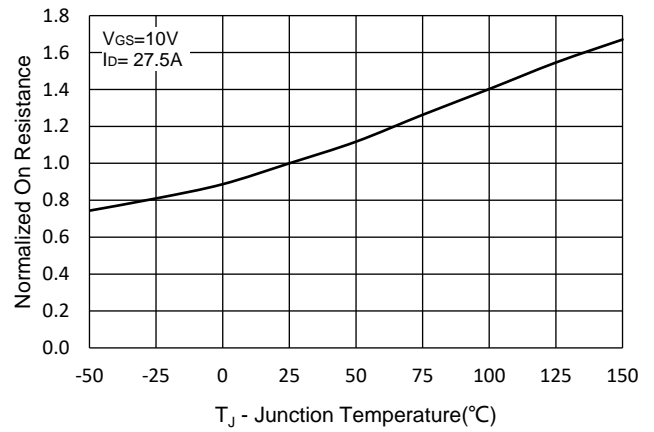


Fig.9 - I_S - V_{SD}

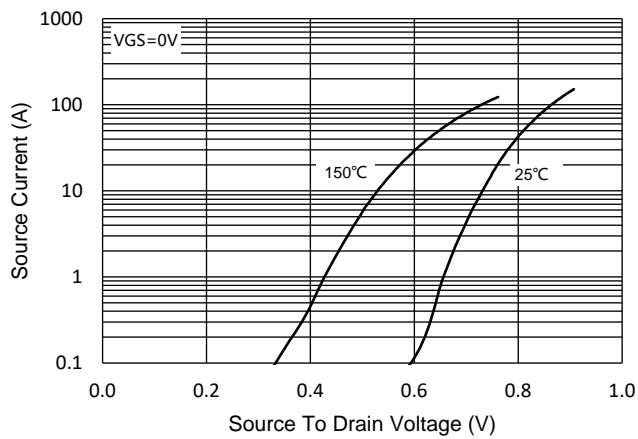


Fig.10 - Drain Current

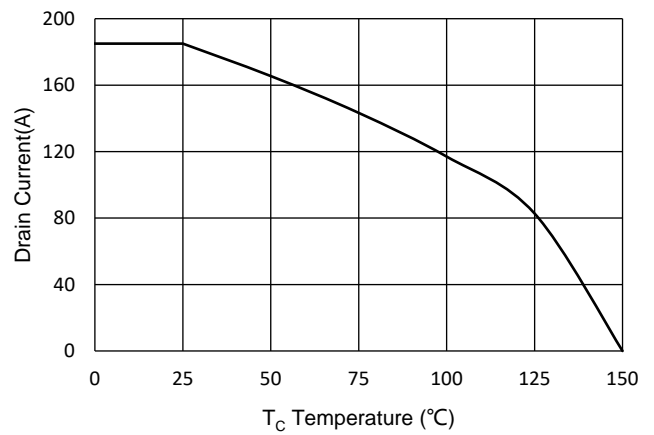
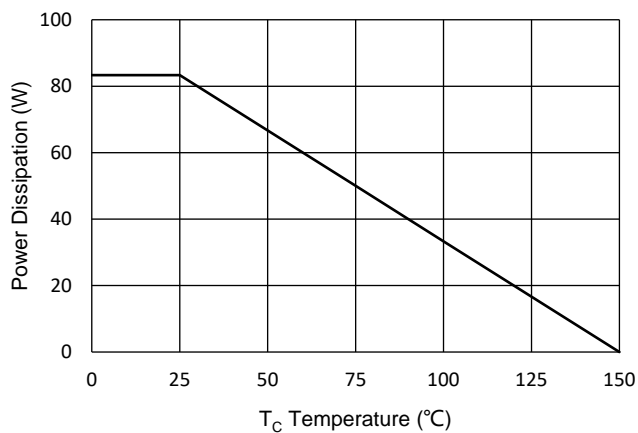


Fig.11 - PD Dissipation



Curve Characteristics

Fig.12 - Safe Operation Area

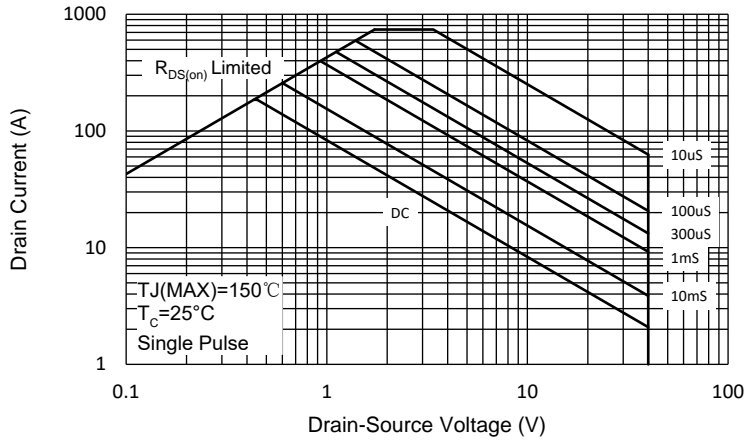
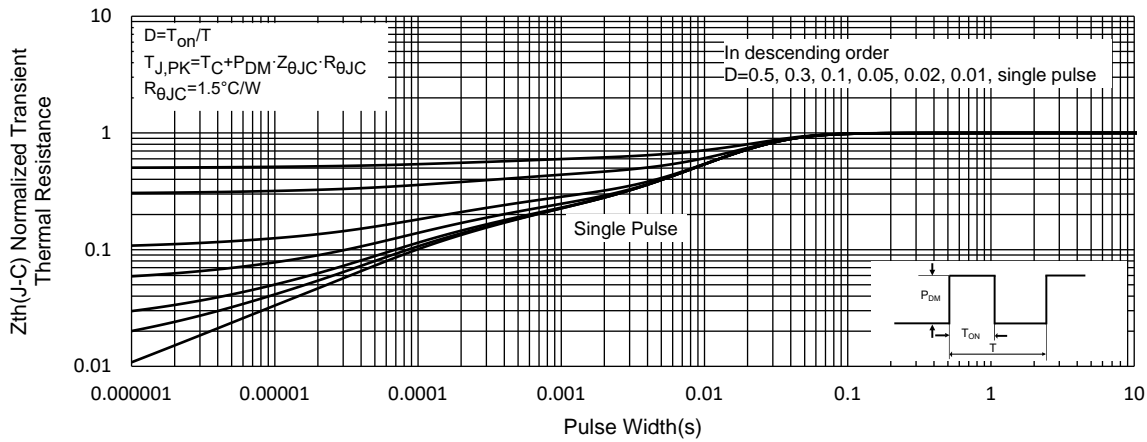


Fig.13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 5Kpcs/Reel

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